



## T2PAK-7 11.80x14.00x3.50, 1.27P

CASE 763AC **ISSUE A** 

### **DATE 20 JUN 2025**

- 1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M,
- 2018.
  CONTROLLING DIMENSION: MILLIMETERS.
  DIMENSIONS b, b2, b3 AND c TO BE MEASURED ON
  FLAT SECTION OF THE LEAD BETWEEN 0.13 AND
  0.25mm FROM LEAD TIP.
  COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL
  AS THE TERMINALS.
  POSITIONAL TOLERANCE APPLIES TO THE TERMINALS
  AND EXPOSED PAD

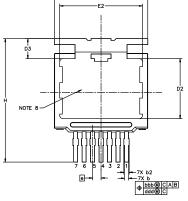
- AND EXPOSED PAD.
  A1 IS DEFINED AS THE VERTICAL DISTANCE FROM THE
  SEATING PLANE TO THE LOWEST POINT OF THE
  PACKAGE BODY.
- PALKAGE BOUY.

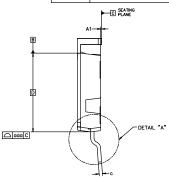
  DIMENSIONS D AND E ARE DETERMINED AT THE
  OUTERMOST EXTREMES OF THE PLASTIC BODY.

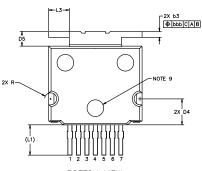
  ALLOWABLE ENCROACHED FLASH ON HEAT SINK AREA
  MAXIMUM OF 0.05mm.
- EJECTOR PINS Ø12.5mm REF.

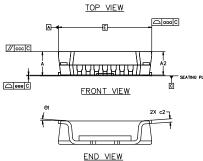
MILLIMETERS					
DIM	MIN	NOM	MAX		
Α	3.53	3.63	3.73		
A1	0.07	0.13	0.18		
A2	3.40	3.50	3.60		
b	0.50	0.60	0.70		
b2	0.50	0.75	1.00		
b3	0.80	0.90	1.00		
С	0.40	0.50	0.60		
c2	0.40	0.50	0.60		
D	11.80 BSC				
D2	8.90	9.00	9.10		
D3	3.00	3.10	3.20		
D4	3.80	3.90	4.00		
D5	2.10	2.20	2.30		
E	14.00 BSC				
E2	12.30	12.40	12.50		
е	1.27 BSC				

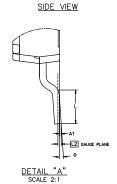
MILLIMETERS				
DIM	MIN	NOM	MAX	
Н	18.00	18.50	19.00	
H1	13.80	14.00	14.20	
L	2.42	2.52	2.62	
L1	4.53 REF			
L2	0.25 BSC			
L3	3.00	3.10	3.20	
R	0.80		1.00	
Θ	0.		8.	
Θ1	0.		8.	
TOLERANCE FORM AND POSITION				
aaa	0.10			
bbb	0.10			
ccc	0.10			
ddd	0.05			
eee	0.05			

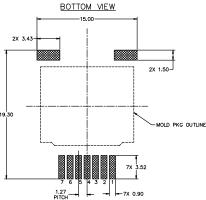












# **GENERIC MARKING DIAGRAM\***

XXXXXX XXXXXX AYWWZZ logo

XXXX = Specific Device Code = Assembly Location

= Year WW = Work Week = Assembly Lot Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

# RECOMMENDED MOUNTING FOOTPRINT

\*For additional information on our Pb-Free strategy and soldering detais, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



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**DESCRIPTION:** 

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